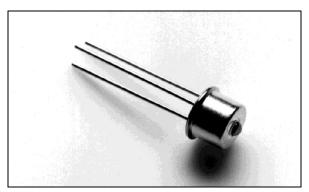


Plastic Optical Fiber Communications - 125 to 250Mbps

Data Sheet



Features

- Optimized wavelength for Plastic optical fiber
- · High Bandwith
- · No threshold
- · Surface emitting
- High coupling efficiency
- · Hermetically sealed

Applications

- IEEE1394b
- 155Mpbs ATM
- Homenetworking
- Industrial applications

DS5612 Issue 1 June 2002

Ordering Information

ZL60003/TBD TO-46 Package

-20 to +70°C

Description

This unique Resonant Cavity Surface-Emitting LED (RCLED) is designed for optical communications over Plastic Optical Fiber (POF) in applications such as IEEE1394b (S100, S200) and 155 Mbps ATM. For very high speed operation, i.e. above 200 Mbps, an electrical pre-emphasis circuit is recommended to increase the bandwidth of the device. ZL60003 is also well suited for applications where visible light is required, such as in sensing and positioning.

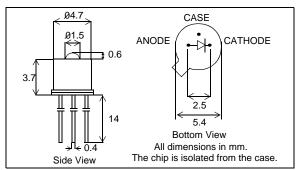


Figure 1 - Pin Description

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition	
Fiber-Coupled Power	P _{fiber}	1.2			mW	/ _F =30mA (Note1)	
Optical Power	Po		2.0		mW	/ _F =30mA	
Beam Divergence (FWHM)	2Θ _{1/2}		25		deg	/ _F =30mA	
Bandwidth (3dBel)	f _C	125			MHz	/ _F =30mA (Note1)	
Peak Wavelength	λр	640	650	660	nm	/ _F =30mA (Note1)	
Spectral Width (FWHM)	Δλ			20	nm	/ _F =30mA (Note1)	
Forward Voltage	V _F			2.3	V	/ _F =30mA	

Note: Fiber: POF 980/1000µm Step Index, NA=0.48. For high speed communication, a low NA POF or a graded index POF are recommended.

Table 1 - Optical and Electronic characteristics (25°C Case temperature)

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ZL60003 Data Sheet

Parameter	Symbol	Limit	
Storage Temperature	T _{stg}	-55 to +125 ⁰ C	
Operating Temperature	T_{op}	-20 to +70 ⁰ C	
Electrical Power Dissipation	P _{tot}	130 mW	
Continuous Forward Current (f<10 kHz)	I _F	40 mA	
Peak Forward Current (duty cycle<50%,f>1 MHz	I _{FRM}	85 mA	
Reverse Voltage	V_{R}	5 V	
Soldering Temperature (2mm from the case for 10 sec.)	T_{sld}	260 ⁰ C	

Table 2 - Absolute Maximum Ratings

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance - Infinite Heat Sink	R_{thjc}		200		OC/W
Thermal Resistance - No Heat Sink	R _{thja}		500		0C/W
Temp. Coefficient - Wavelength	$d\lambda/dT_j$		0.08		nm/ ⁰ C
Optical Power - Fiber Coupled	dP_f/dT_j		-0.7		%/ ⁰ C

Table 3 - Thermal Characteristics

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